



**TN2460L/TN2460T**  
Vishay Siliconix

**N-Channel 240-V (D-S) MOSFET**

PRODUCT SUMMARY				
Part Number	V <sub>(BR)DSS</sub> Min (V)	r <sub>DS(on)</sub> Max (Ω)	V <sub>GS(th)</sub> (V)	I <sub>D</sub> Min (mA)
TN2460L	240	60 @ V <sub>GS</sub> = 10 V	0.5 to 1.8	75
TN2460T		60 @ V <sub>GS</sub> = 10 V	0.5 to 1.8	51

**FEATURES**

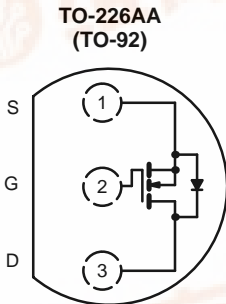
- Low On-Resistance: 40 Ω
- Secondary Breakdown Free: 260 V
- Low Power/Voltage Driven
- Low Input and Output Leakage
- Excellent Thermal Stability

**BENEFITS**

- Low Offset Voltage
- Full-Voltage Operation
- Easily Driven Without Buffer
- Low Error Voltage
- No High-Temperature "Run-Away"

**APPLICATIONS**

- High-Voltage Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Transistors, etc.
- Telephone Mute Switches, Ringer Circuits
- Power Supply, Converters
- Motor Control

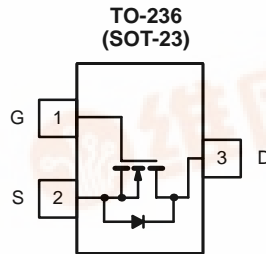


Top View  
TN2460L

Device Marking Front View

"S" TN  
2406L  
xxyy

"S" = Siliconix Logo  
xxyy = Date Code



Top View

Marking Code: T2wll

T2 = Part Number Code for TN2460T  
w = Week Code  
ll = Lot Traceability

ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25 °C UNLESS OTHERWISE NOTED)					
Parameter	Symbol	TN2460L	TN2460T	Unit	
Drain-Source Voltage	V <sub>DS</sub>	240	240	V	
Gate-Source Voltage	V <sub>GS</sub>	± 20	± 20		
Continuous Drain Current (T <sub>J</sub> = 150 °C)	I <sub>D</sub>	T <sub>A</sub> = 25 °C	75	51	mA
		T <sub>A</sub> = 100 °C	48	32	
Pulsed Drain Current <sup>a</sup>	I <sub>DM</sub>	800	400		
Power Dissipation	P <sub>D</sub>	T <sub>A</sub> = 25 °C	0.8	0.36	W
		T <sub>A</sub> = 100 °C	0.32	0.14	
Thermal Resistance, Junction-to-Ambient	R <sub>thJA</sub>	156	350	°C/W	
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to 150		°C	

Notes:  
a. Pulse width limited by maximum junction temperature.

# TN2460L/TN2460T

Vishay Siliconix



SPECIFICATIONS (T <sub>A</sub> = 25 °C UNLESS OTHERWISE NOTED)						
Parameter	Symbol	Test Conditions	Limits			Unit
			Min	Typ <sup>a</sup>	Max	
<b>Static</b>						
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 10 μA	240	260		V
Gate-Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA	0.5	1.65	1.8	
Gate-Body Leakage	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ±20 V T <sub>J</sub> = 125 °C		±5	±10	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 120 V, V <sub>GS</sub> = 0 V T <sub>J</sub> = 125 °C			0.1	μA
					5	
On-State Drain Current <sup>b</sup>	I <sub>D(on)</sub>	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 10 V	75	140		mA
		V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 4.5 V	20	130		
Drain-Source On-Resistance <sup>b</sup>	r <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 0.05 A		38	60	Ω
		V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 0.02 A		40	60	
		T <sub>J</sub> = 125 °C		75	120	
Forward Transconductance <sup>b</sup>	g <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 0.05 A	30	70		mS
<b>Dynamic</b>						
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, f = 1 MHz		14	30	pF
Output Capacitance	C <sub>oss</sub>			4	15	
Reverse Transfer Capacitance	C <sub>rss</sub>			1	10	
<b>Switching<sup>c</sup></b>						
Turn-On Time	t <sub>ON</sub>	V <sub>DD</sub> = 25 V, R <sub>L</sub> = 500 Ω I <sub>D</sub> ≅ 0.05 A, V <sub>GEN</sub> = 10 V, R <sub>G</sub> = 25 Ω		8	20	ns
Turn-Off Time	t <sub>OFF</sub>			20	35	

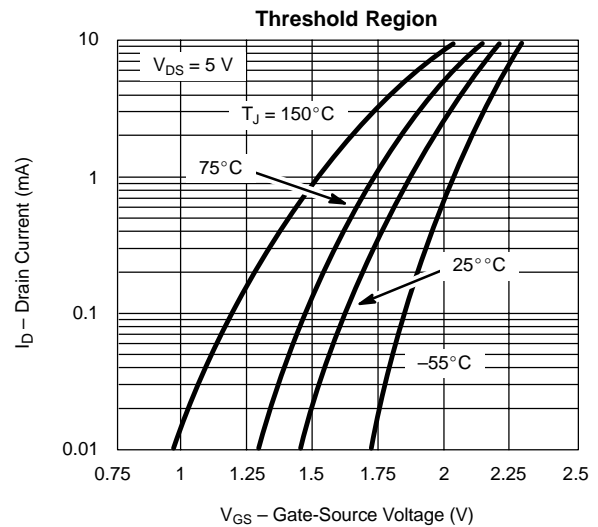
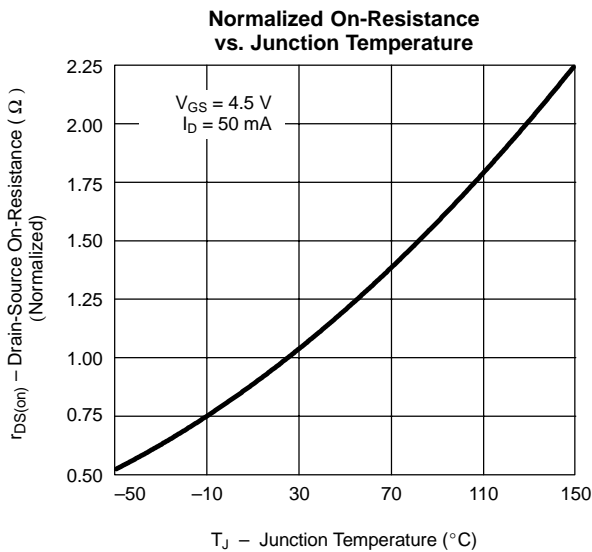
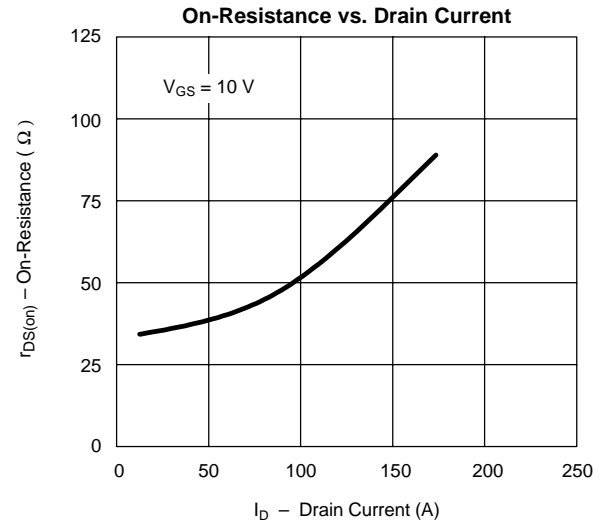
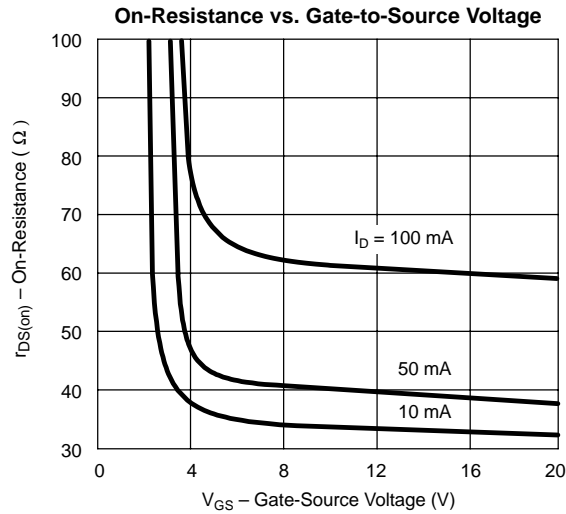
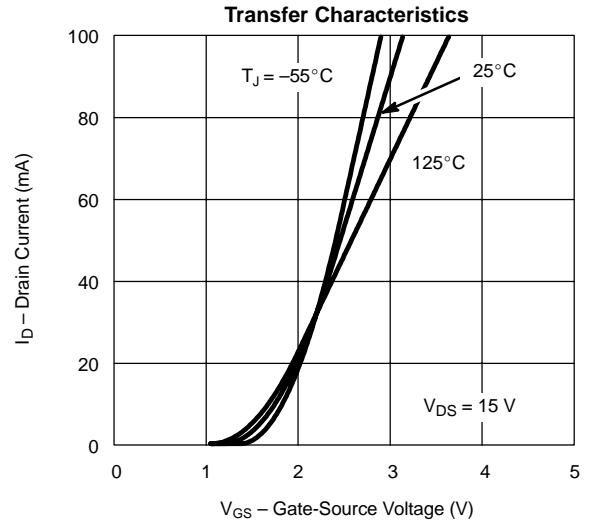
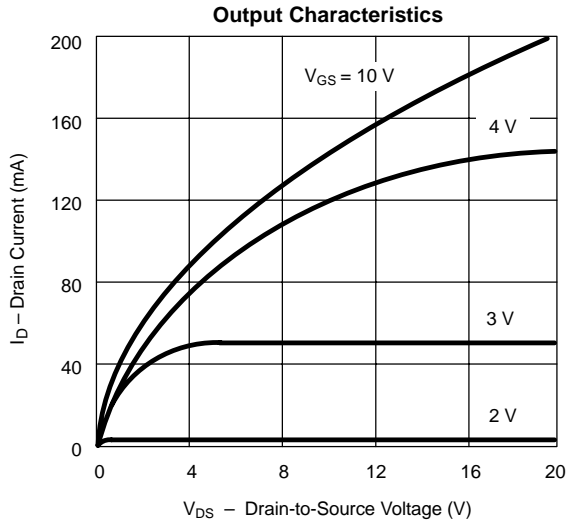
**Notes**

- a. For DESIGN AID ONLY, not subject to production testing.
- b. Pulse test: PW ≤ 80 μs duty cycle ≤ 1%.
- c. Switching time is essentially independent of operating temperature.

VNDN24



**TYPICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$  UNLESS OTHERWISE NOTED)**





**TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25°C UNLESS OTHERWISE NOTED)**

